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FDD3860

N-Channel PowerTrench[®] MOSFET 100 V, 29 A, 36 m Ω

Features

- Max $r_{DS(on)}$ = 36 m Ω at V_{GS} = 10 V, I_D = 5.9 A
- High Performance Trench Technology for Extremely Low r_{DS(on)}
- 100% UIL Tested
- RoHS Compliant

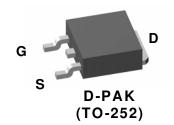


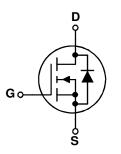
General Description

This N-Channel MOSFET is rugged gate version of ON Semiconductor's advanced Power Trench[®] process. This part is tailored for low $r_{DS(on)}$ and low Qg figure of merit, with avalanche ruggedness for a wide range of switching applications.

Applications

- DC-AC Conversion
- Synchronous Rectifier





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25°C		29		
	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	6.2	Α	
	-Pulsed			60		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P _D	Power Dissipation	T _C = 25°C		83	w	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.75	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

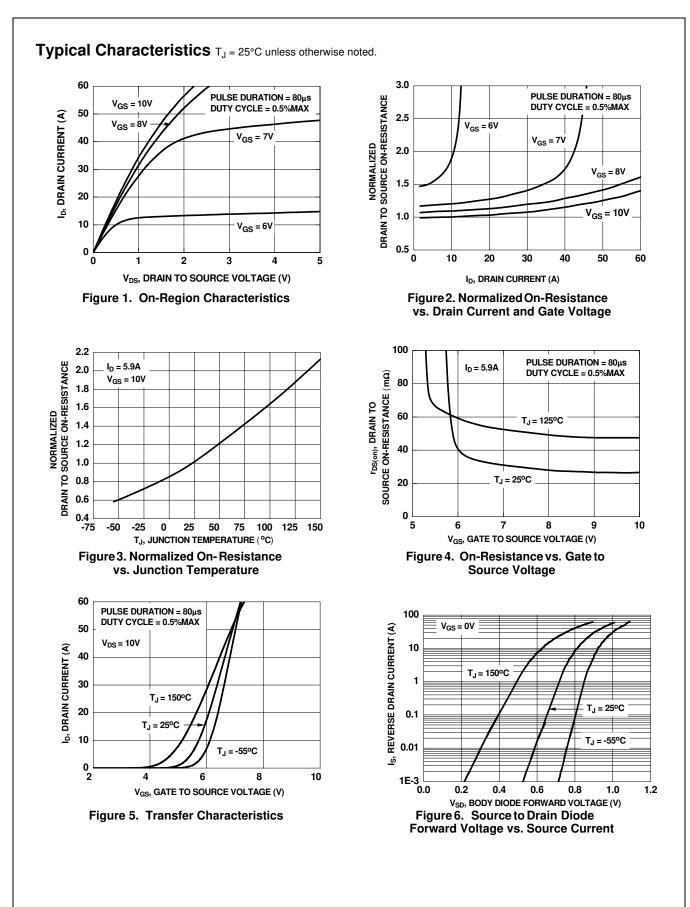
Thermal Characteristics

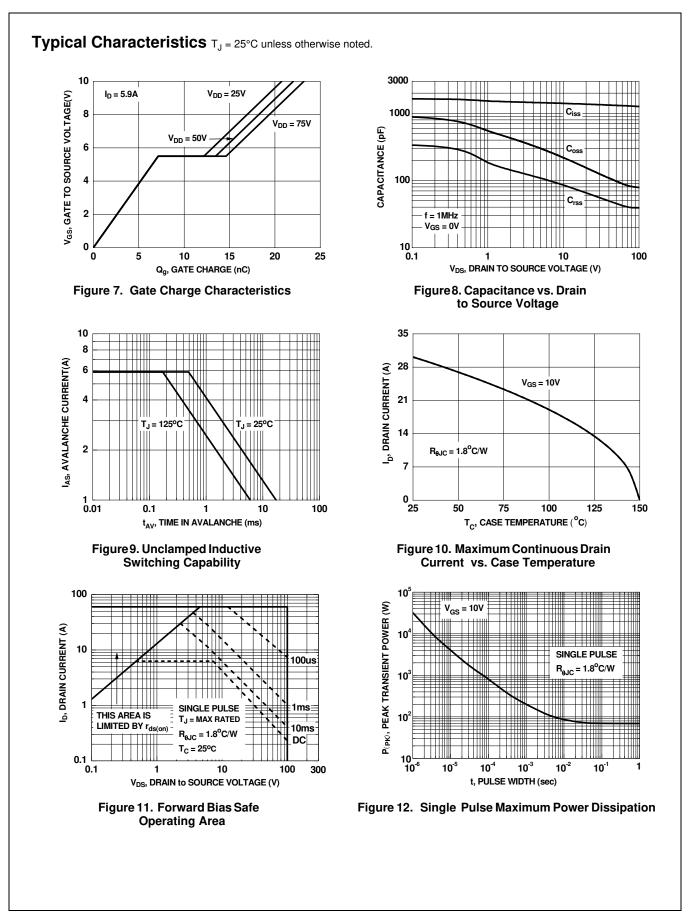
R_{\thetaJC}	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/ VV

Package Marking and Ordering Information

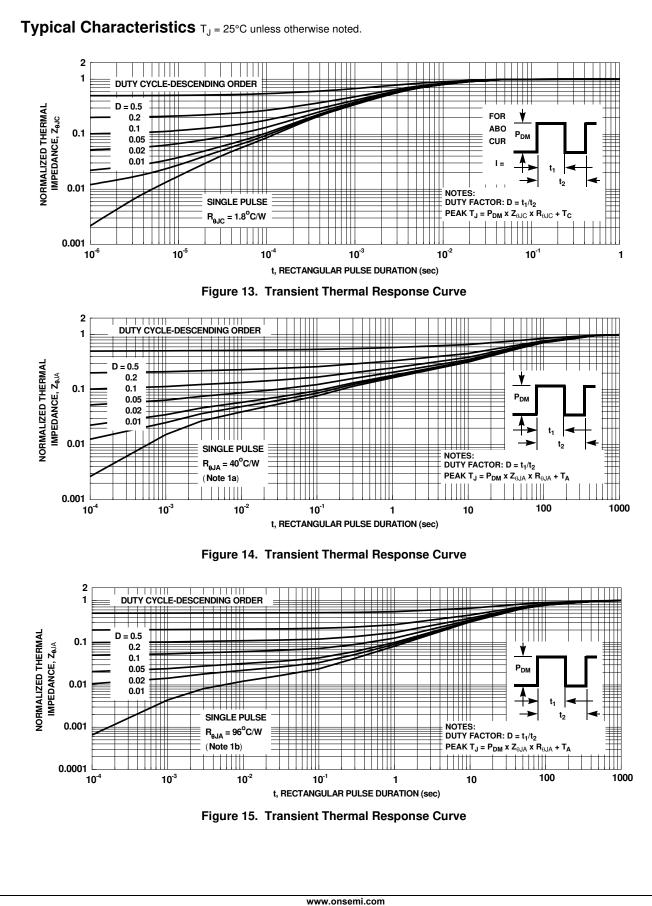
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD3860	FDD3860	D-PAK (TO-252)	13"	16 mm	2500 units

	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	icteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	100			V
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		98		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.8	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-11.4		mV/°C
r _{no()}	Static Drain to Source On Resistance	V _{GS} = 10V, I _D = 5.9A		29	36	- mΩ
r _{DS(on)}		$V_{GS} = 10V, I_D = 5.9A, T_J = 125^{\circ}C$		51	64	1115.2
9fs	Forward Transconductance	$V_{DS} = 10V, I_{D} = 5.9A$		20		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1310	1740	pF
C _{oss}	Output Capacitance	$V_{\rm DS} = 50V, V_{\rm GS} = 0V,$		100	130	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		45	70	pF
R _g	Gate Resistance	f = 1MHz		1.6		Ω
	g Characteristics			10	00	
t _{d(on)}	Turn-On Delay Time	V _{DD} = 50V, I _D = 5.9A,		16	29	ns
t _r	Rise Time	$-V_{GS} = 10V, R_{GEN} = 6\Omega$		10	21	ns
t _{d(off)}	Turn-Off Delay Time			24 7	39	ns
t _f	Fall Time				15	ns
Q _g	Total Gate Charge at 10V	V _{DD} = 50V, I _D = 5.9A		22	31	nC
Q _{gs}	Gate to Source Charge	_		7.1		nC
Q _{gd}	Gate to Drain "Miller" Charge			6.3		nC
Drain-Soເ	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.0A$ (Note 2)		0.7	1.2	V
	-	$V_{GS} = 0V, I_S = 5.9A$ (Note 2)		0.8	1.3	
t _{rr}	Reverse Recovery Time	— I _F = 5.9A, di/dt = 100A/μs		34	55	ns
Q _{rr}	Reverse Recovery Charge			40	64	nC





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